



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Art Unit: 1765  
Examiner: Lan Vinh

In re PATENT APPLICATION of:

Applicant	:	Toyokazu SAKATA	)	<b>SUPPLEMENTAL <u>RESPONSE</u></b>
Serial No.	:	10/721,260	)	
Filed	:	November 26, 2003	)	
For	:	ETCHING METHOD AND SEMICONDUCTOR DEVICE FABRICATING METHOD	)	
Attorney Ref.	:	TAI 145	)	

May 3, 2006

**Box AF**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The present Supplemental Response is being filed in further reply to the Office Action of January 5, 2006, and additionally in reply to the Advisory Action dated April 17, 2006. A Petition for Extension of Time is being filed concurrently.

A fee of \$ \_\_\_\_\_ is also being submitted concurrently. Should this remittance be accidentally missing, however, or should any additional fees be needed (including extension of time fees, since Applicant hereby provisionally petitions for any extensions that may be deemed necessary to avoid abandonment), the Director may charge such fees to our Deposit Account number 18-0002.

Please reconsider the above-identified application in view of the Remarks that are presented on the following pages.

*Q10*  
FEE ENCL OF  
Please charge any further  
fee to our Deposit Account  
No. 18-0002